

N and P-Channel Enhancement Mode Power MOSFET

Description

The HM4630D uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

N-Channel

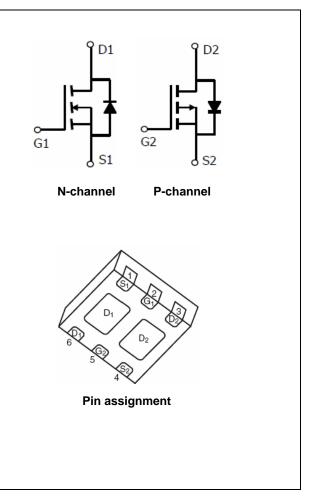
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V_{DS} = 30V,I_{D} =5A
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 $R_{DS(ON)} < 36m\Omega @ V_{GS}=4.5V$ $R_{DS(ON)} < 52m\Omega @ V_{GS}=2.5V$

• P-Channel

 $V_{DS} = -30V, I_D = -5A$ $R_{DS(ON)} < 6.5m\Omega @ V_{GS} = -4.5V$ $R_{DS(ON)} < 120m\Omega @ V_{GS} = -2.5V$

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|---------|----------------|-----------|------------|------------|
| 4630 | HM4630D | DFN2X2-6L | Ø180mm | 8mm | 3000 units |

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

| Param | Symbol | N-Channel | P-Channel | Unit | | | |
|-----------------------------------|----------------------------------|-----------------|------------|------|---|--|--|
| Drain-Source Voltage | V _{DS} | 30 | -30 | V | | | |
| Gate-Source Voltage | | V _{GS} | ±12 | ±12 | V | | |
| Continuous Drain Current | T _A =25℃ | | 5 | -5 | A | | |
| Continuous Drain Current | T _A =70℃ | I _D | 3.5 | -3.5 | | | |
| Pulsed Drain Current (Note 1) | | I _{DM} | 15 | -15 | А | | |
| Maximum Power Dissipation | T _A =25℃ | PD | 0.8 | 0.8 | W | | |
| Operating Junction and Storage 1 | T _J ,T _{STG} | -55 To 150 | -55 To 150 | °C | | | |
| Thermal Characteristic | | | | | | | |
| Thermal Resistance, Junction-to-A | $R_{	extsf{	heta}JA}$ | N-Ch | 156 | °C/W | | | |
| Thermal Resistance, Junction-to-A | $R_{	extsf{	heta}JA}$ | P-Ch | 156 | °C/W | | | |



N-CH Electrical Characteristics (T_A=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|---|-----|-----|------|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250µA | 20 | 22 | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =30V,V _{GS} =0V | - | - | 1 | μA |
| Gate-Body Leakage Current | I _{GSS} | V_{GS} =±12V, V_{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | · | | | | | • |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS}$, $I_D=250\mu A$ | 0.6 | 0.9 | 1.4 | V |
| Drain-Source On-State Resistance | Р | V _{GS} =2.5V, I _D =2.8A | - | 46 | 52 | mΩ |
| Dian-Source On-State Resistance | R _{DS(ON)} | V_{GS} =4.5V, I_{D} =5A | - | 30 | 36 | mΩ |
| Forward Transconductance | g fs | V _{DS} =5V,I _D =5A | - | 8 | - | S |
| Dynamic Characteristics (Note4) | · | | | | | |
| Input Capacitance | C _{Iss} | | - | 260 | - | PF |
| Output Capacitance | C _{oss} | V _{DS} =10V,V _{GS} =0V, F=1.0MHz | - | 48 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | | - | 27 | - | PF |
| Switching Characteristics (Note 4) | | | - | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 2.5 | - | nS |
| Turn-on Rise Time | tr | V_{DD} =10V, R _L =3.3 Ω | - | 3.2 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =4.5V, R_{GEN} =6 Ω | - | 21 | - | nS |
| Turn-Off Fall Time | t _f | | - | 3 | - | nS |
| Total Gate Charge | Qg | | - | 2.9 | 5 | nC |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 10V, I_D = 5A,$ | - | 0.4 | - | nC |
| Gate-Drain Charge | Q _{gd} | V _{GS} =4.5V | - | 0.6 | - | nC |
| Drain-Source Diode Characteristics | | | | | • | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =5A | - | - | 1.2 | V |
| Diode Forward Current (Note 2) | Is | | - | - | 5 | Α |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production



P-CH Electrical Characteristics (TA=25°Cunless otherwise noted

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|--|------|------|------|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =-250µA | -20 | | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-30V,V _{GS} =0V | - | - | -1 | μA |
| Gate-Body Leakage Current | I _{GSS} | V_{GS} =±12V, V_{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS}$, $I_{D}=-250\mu A$ | -0.6 | -0.9 | -2.0 | V |
| Drain Course On State Desistance | D | V_{GS} =-4.5V, I _D =-2.5 A | - | 60 | 165 | mΩ |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =-2.5V, I _D =-2A | - | 95 | 120 | mΩ |
| Forward Transconductance | g fs | V _{DS} =-5V,I _D =-2.5A | - | 9.5 | - | S |
| Dynamic Characteristics (Note4) | | | L | | | |
| Input Capacitance | C _{lss} | | - | 325 | - | PF |
| Output Capacitance | C _{oss} | V _{DS} =-10V,V _{GS} =0V, F=1.0MHz | - | 63 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.0MHZ | - | 37 | - | PF |
| Switching Characteristics (Note 4) | | | | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 11 | - | nS |
| Turn-on Rise Time | tr | V_{DD} =-10V, R _L =5 Ω | - | 5.5 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =-4.5V, R_{GEN} =3 Ω | - | 22 | - | nS |
| Turn-Off Fall Time | t _f | | - | 8 | - | nS |
| Total Gate Charge | Qg | | - | 3.2 | - | nC |
| Gate-Source Charge | Q _{gs} | V_{DS} =-10V,I _D =-2A, | - | 0.6 | - | nC |
| Gate-Drain Charge | Q _{gd} | V_{GS} =-4.5V | - | 0.9 | - | nC |
| Drain-Source Diode Characteristics | I | | | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =-5A | - | - | -1.2 | V |
| Diode Forward Current (Note 2) | Is | | _ | - | -5 | Α |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

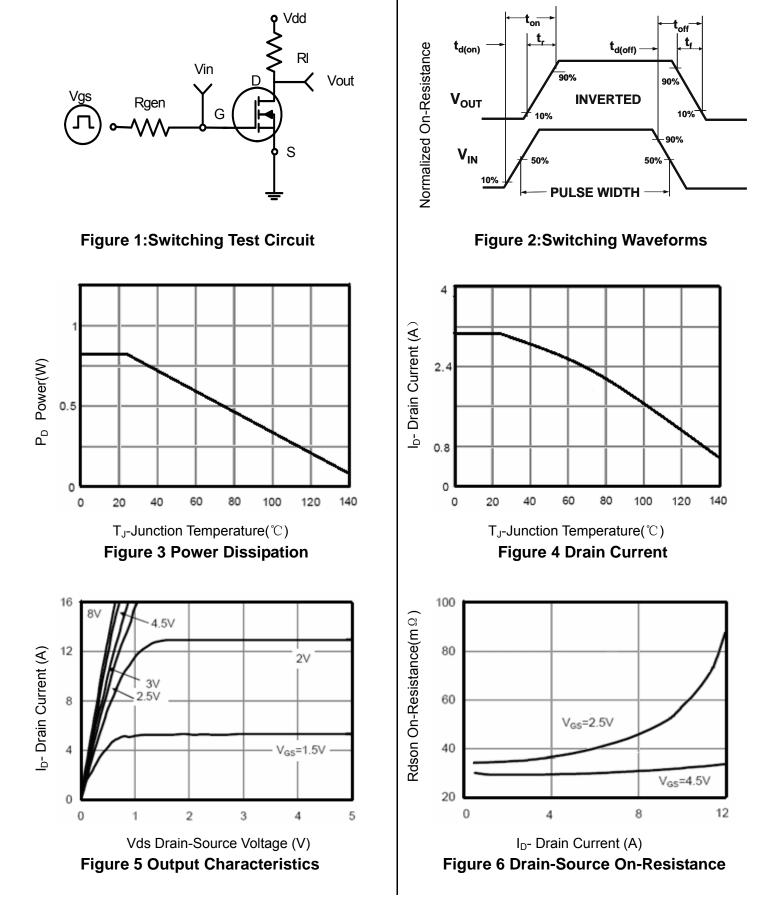
2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

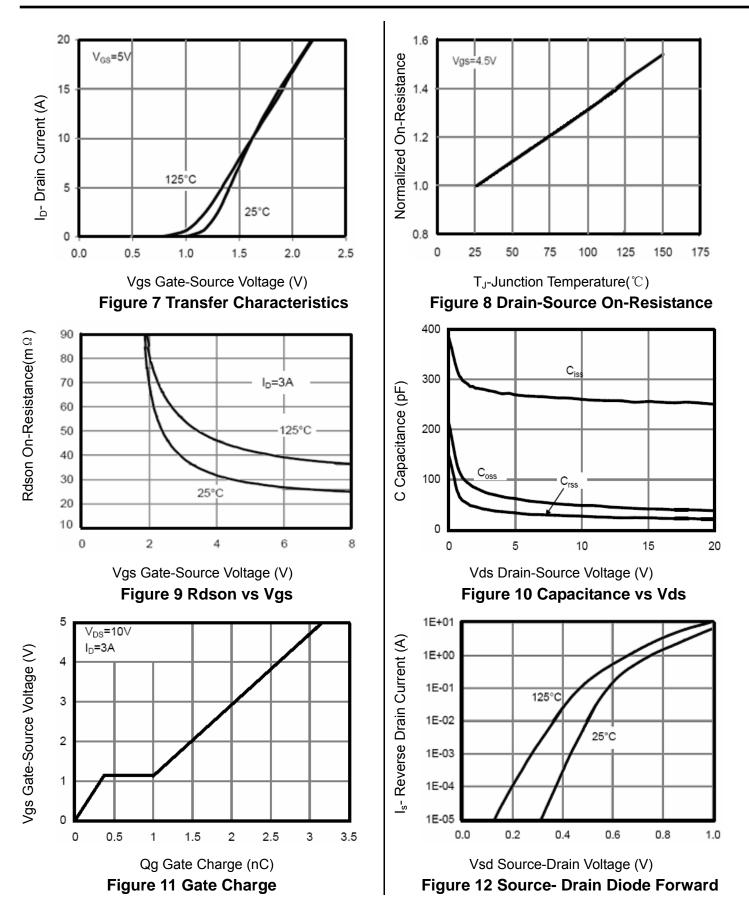
4. Guaranteed by design, not subject to production



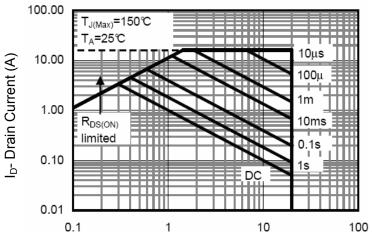
N- Channel Typical Electrical and Thermal Characteristics (Curves)



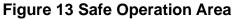


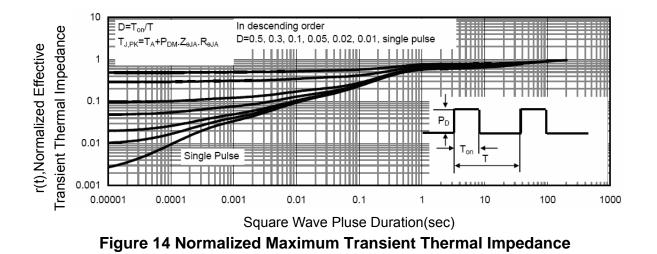






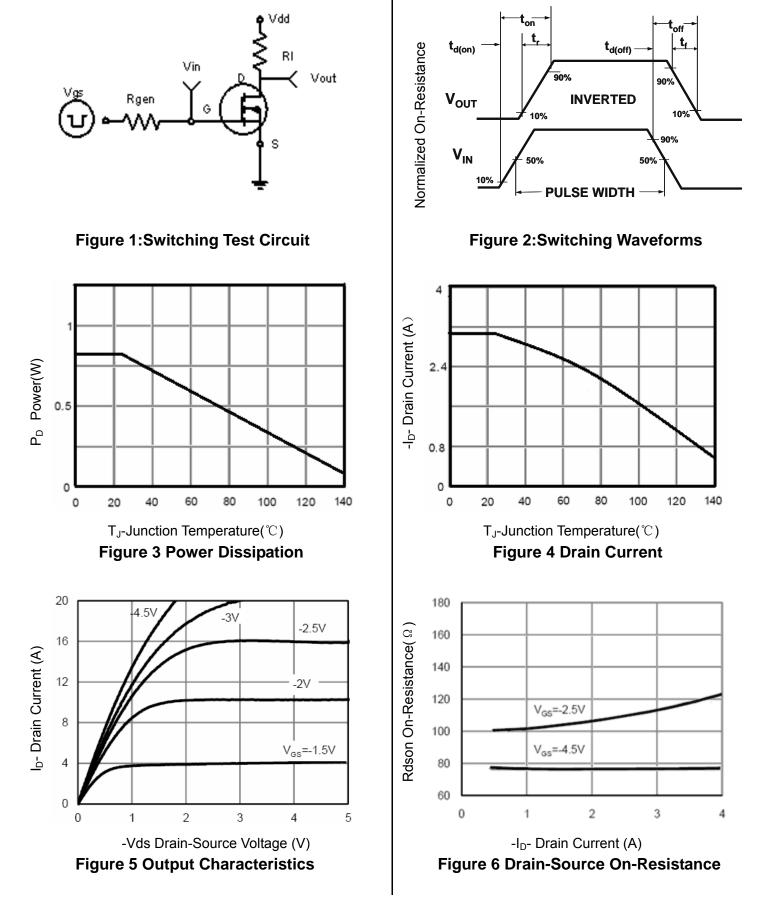
Vds Drain-Source Voltage (V)





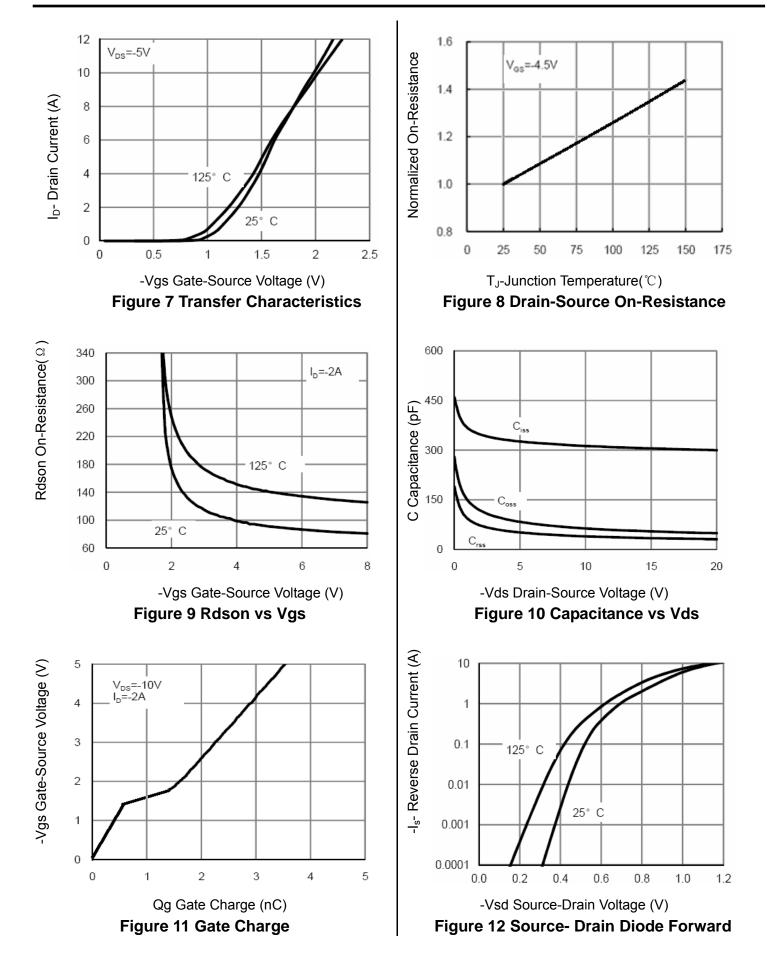


P- Channel Typical Electrical and Thermal Characteristics (Curves)





HM4630D





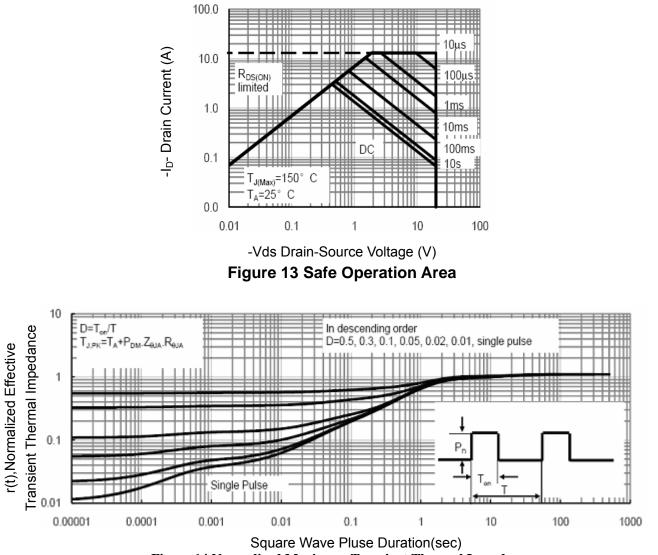
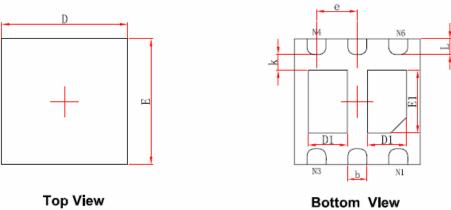


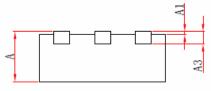
Figure 14 Normalized Maximum Transient Thermal Impedance



DFN2X2-6L Package Information







Side View

| Sumbol | Dimensions I | n Millimeters | Dimensions In Inches | | |
|--------|--------------|---------------|----------------------|-------------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| A | 0.700/0.800 | 0.800/0.900 | 0.028/0.031 | 0.031/0.035 | |
| A1 | 0.000 | 0.050 | 0.000 | 0.002 | |
| A3 | 0.203 | REF. | 0.008REF. | | |
| D | 1.924 | 2.076 | 0.076 | 0.082 | |
| E | 1.924 | 2.076 | 0.076 | 0.082 | |
| D1 | 0.520 | 0.720 | 0.020 | 0.028 | |
| E1 | 0.900 | 1.100 | 0.035 | 0.043 | |
| k | 0.200 | ÓMIN. | 0.008MIN. | | |
| b | 0.250 | 0.350 | 0.010 | 0.014 | |
| e | 0.650 | TYP. | 0.026TYP. | | |
| L | 0.174 | 0.326 | 0.007 | 0.013 | |



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